

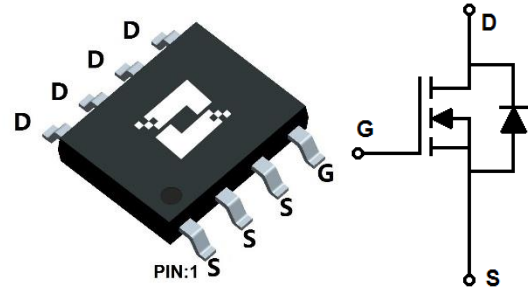
Features

- Low $R_{DS(on)}$ @ $V_{GS}=10V$
- 5V Logic Level Control
- N Channel SOP8 Package
- Pb-Free, RoHS Compliant

$V_{(BR)DSS}$	$R_{DS(ON)}$ Typ	I_D Max
30V	8.2m Ω @ 10V	15A
	11.5m Ω @ 4.5V	

Applications

- High-Speed Switching
- General Purpose Applications
- Power Management Applications
- Load Switch
- Hand-Held Instruments


SOP8
Order Information

Product	Package	Marking	Packing
DWS009N03	SOP8	009N03	4000PCS/Reel

Absolute Maximum Ratings

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

Symbol	Parameter	Rating	Unit
Common Ratings ($T_J=25^\circ\text{C}$ Unless Otherwise Noted)			
V_{GS}	Gate-Source Voltage	± 20	V
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	30	V
$T_{J, STG}$	Junction and Storage Temperature Range	-50 to 150	$^\circ\text{C}$
Mounted on Large Heat Sink			
I_{DM}	Pulse Drain Current Tested ^①	$T_A=25^\circ\text{C}$	60 A
I_D	Continuous Drain Current	$T_A=25^\circ\text{C}$	15 A
		$T_A=70^\circ\text{C}$	12 A
P_D	Maximum Power Dissipation	$T_A=25^\circ\text{C}$	3.1 W
$R_{\theta JA}$	Maximum Junction-to-Ambient		40 $^\circ\text{C/W}$

Symbol	Parameter	Condition	Min	Typ	Max	Unit
Static Electrical Characteristics @ T_J = 25°C (unless otherwise stated)						
V _{(BR)DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =250μA	30	--	--	V
I _{DSS}	Zero Gate Voltage Drain Current(T _A =25°C)	V _{DS} =30V, V _{GS} =0V	--	--	1	μA
	Zero Gate Voltage Drain Current(T _A =125°C)	V _{DS} =24V, V _{GS} =0V	--	--	100	uA
I _{GSS}	Gate-Body Leakage Current	V _{GS} =±20V, V _{DS} =0V	--	--	±100	nA
V _{GS(TH)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =250μA	1.0	1.8	2.5	V
R _{DS(ON)}	Drain-Source On-State Resistance②	V _{GS} =10V, I _D =10A	--	8.2	10	mΩ
R _{DS(ON)}	Drain-Source On-State Resistance②	V _{GS} =4.5V, I _D =5A	--	11.5	15	mΩ
Dynamic Electrical Characteristics @ T_J = 25°C (unless otherwise stated)						
C _{iss}	Input Capacitance	V _{DS} =15V, V _{GS} =0V, f=1MHz	--	804	--	pF
C _{oss}	Output Capacitance		--	129	--	pF
C _{rss}	Reverse Transfer Capacitance		--	95	--	pF
R _g	Gate Resistance	f=1MHz		3.7		Ω
Q _g	Total Gate Charge	V _{DS} =15V I _D =20A, V _{GS} =10V	--	15.6	--	nC
Q _{gs}	Gate Source Charge		--	3	--	nC
Q _{gd}	Gate Drain Charge		--	4.1	--	nC
Switching Characteristics @ T_J = 25°C (unless otherwise stated)						
t _{d(on)}	Turn on Delay Time	V _{DD} =15V, I _D =1A, R _G =3.3Ω, V _{GS} =10V	--	6.5	--	ns
t _r	Turn on Rise Time		--	3	--	ns
t _{d(off)}	Turn Off Delay Time		--	20	--	ns
t _f	Turn Off Fall Time		--	5.2	--	ns
Source Drain Diode Characteristics @ T_J = 25°C (unless otherwise stated)						
I _{SD}	Source drain current(Body Diode)	T _A =25°C	--	--	4	A
V _{SD}	Forward on voltage②	T _J =25°C, I _{SD} =5A, V _{GS} =0V	--	0.78	1.2	V

Notes: ① Pulse width limited by maximum allowable junction temperature

②Pulse width ≤ 300μs; duty cycle≤ 2%.

Typical Characteristics

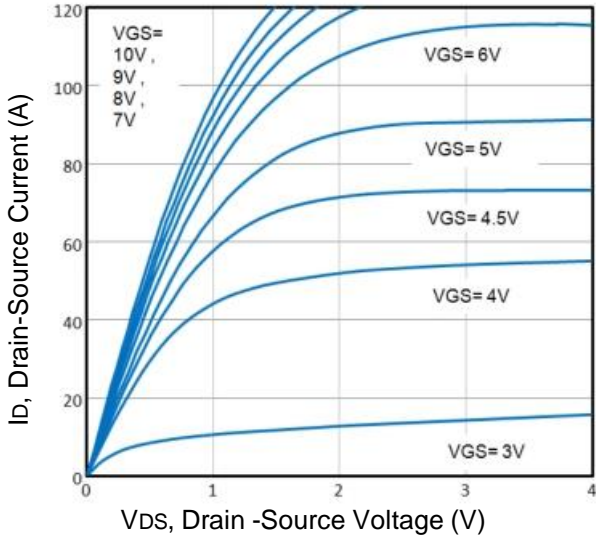


Fig1. Typical Output Characteristics

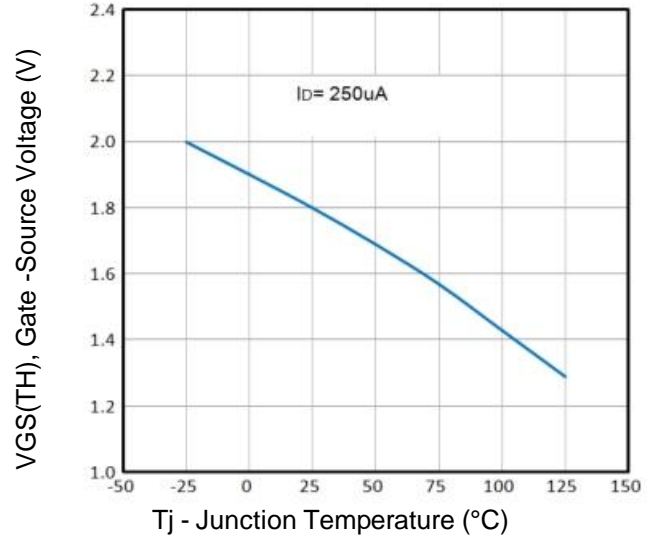


Fig2. VGS(TH) Voltage Vs. Temperature

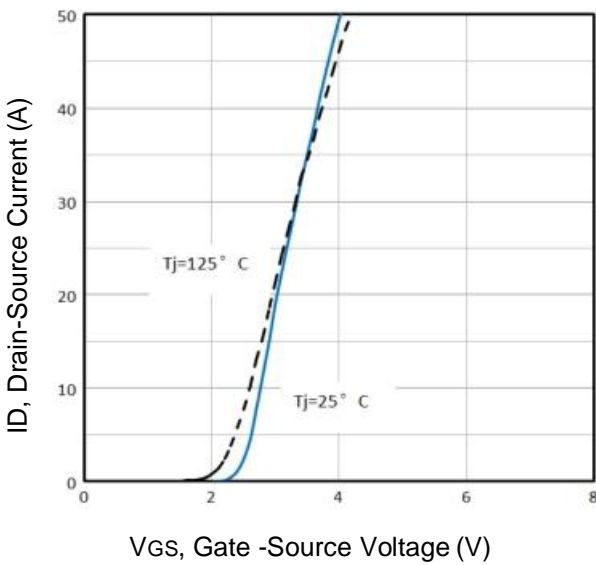


Fig3. Typical Transfer Characteristics

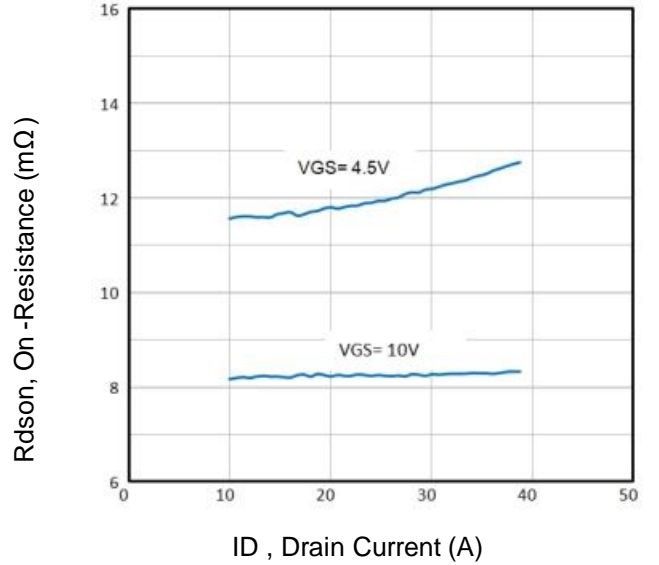


Fig4. On-Resistance vs. Drain Current and Gate

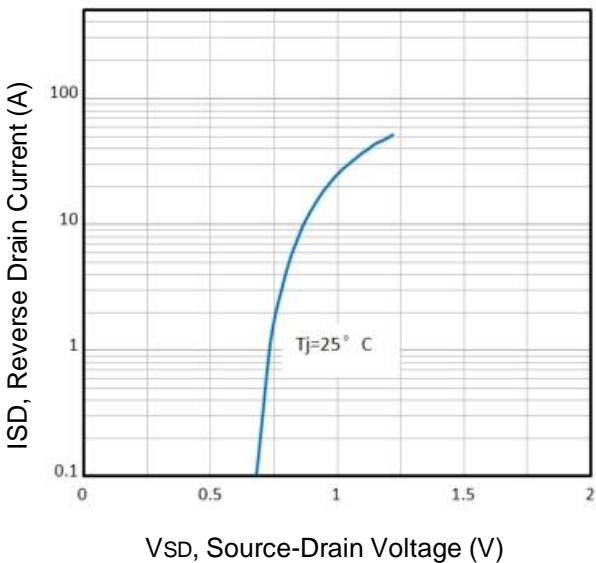


Fig5. Typical Source-Drain Diode Forward Voltage

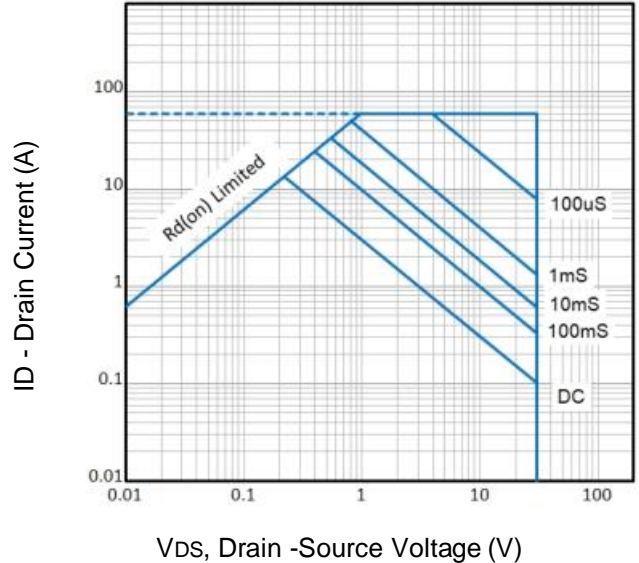


Fig6. Maximum Safe Operating Area

Typical Characteristics

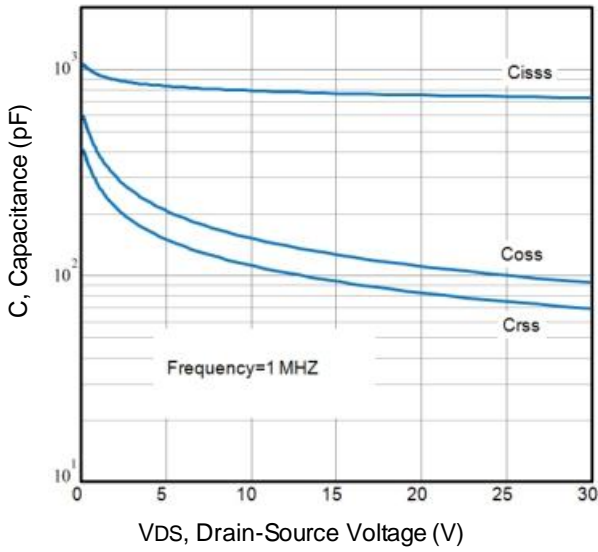


Fig7. Typical Capacitance Vs. Drain-Source Voltage

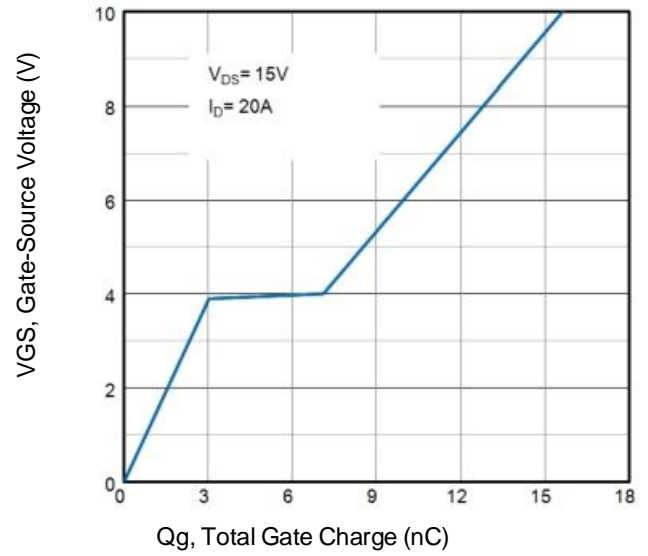


Fig8. Typical Gate Charge Vs. Gate-Source Voltage

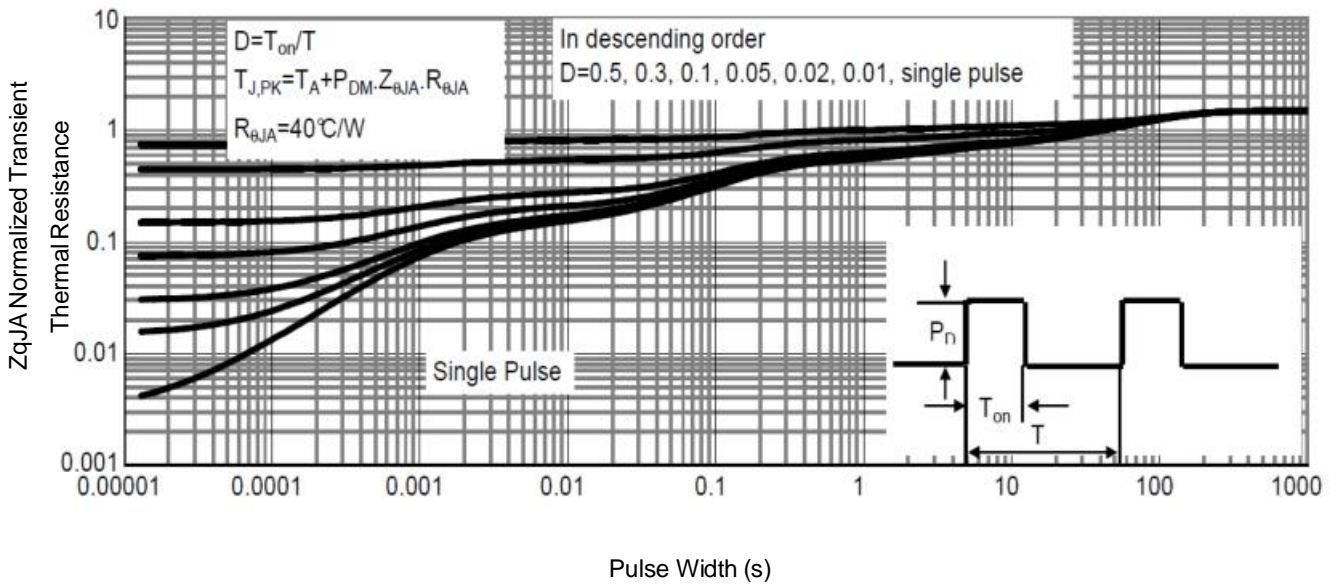


Fig9. Normalized Maximum Transient Thermal Impedance

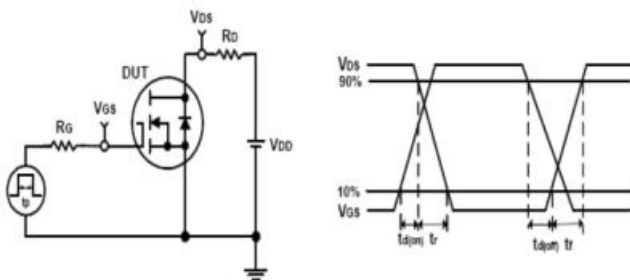


Fig10. Switching Time Test Circuit and waveforms

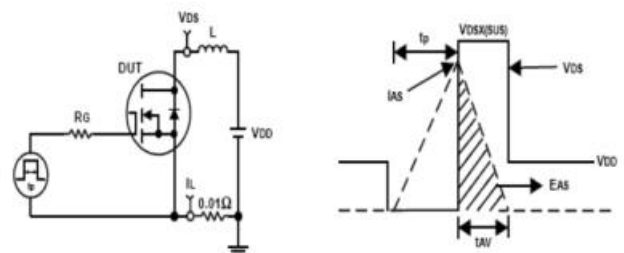
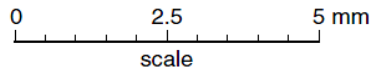
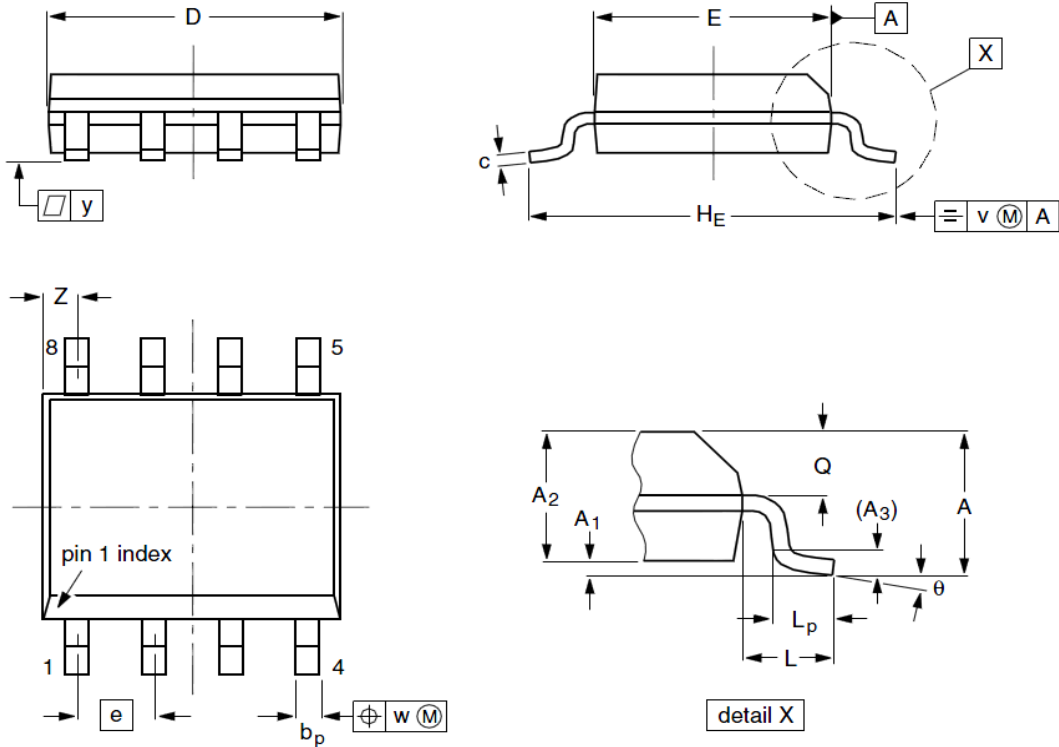


Fig11. Unclamped Inductive Test Circuit and waveforms

SOP8 Mechanical Data



DIMENSIONS (unit : mm)

Symbol	Min	Typ	Max	Symbol	Min	Typ	Max
A	--	1.75	--	A ₁	0.10	0.18	0.25
A ₂	1.25	1.35	1.45	A ₃	--	0.25	--
b _p	0.36	0.42	0.49	c	0.19	0.22	0.25
D	4.80	4.92	5.00	E	3.80	3.90	4.00
e	--	1.27	--	H _E	5.80	5.98	6.20
L	--	1.05	--	L _p	0.40	0.68	1.00
Q	0.60	0.65	0.70	v	--	0.25	--
w	--	0.25	--	y	--	0.10	--
Z	0.30	0.50	0.70	θ	0°		8°

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